

| | Type | Hits | Search Text | DBs | Time Stamp |
|---|------|------|---|---|------------------|
| 1 | IS&R | 4308 | (257/751,752,753,758,759,761,762,763).CC LS. | USPAT | 2006/03/22 16:05 |
| 2 | IS&R | 3109 | (257/751,752,753,758,759,761,762,763).CC LS. | US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/03/22 16:14 |
| 3 | BRS | 453 | (cobalt Co) with (tungsten W) with (phosphorus phosphide P) with (percent percentage "%") | USPAT | 2006/03/22 16:24 |
| 4 | BRS | 2062 | (cobalt Co) with (tungsten W) with (phosphorus phosphide P) with (percent percentage "%") | US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/03/23 06:48 |
| 5 | BRS | 315 | (cap passivation barrier diffusion adhesive adhesion film layer) and ((cobalt Co) with (tungsten W) with (phosphorus phosphide P) with (percent percentage "%")) | USPAT | 2006/03/23 09:01 |
| 6 | BRS | 82 | (cap passivation barrier diffusion adhesive adhesion film layer) same ((cobalt Co) with (tungsten W) with (phosphorus phosphide P) with (percent percentage "%")) | USPAT | 2006/03/23 09:01 |
| 7 | BRS | 243 | (cap passivation barrier diffusion adhesive adhesion film layer) same ((cobalt Co) with (tungsten W) with (phosphorus phosphide P) with (percent percentage "%")) | US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/03/23 09:28 |
| 8 | BRS | 148 | ((((cobalt Co) with (tungsten W) with (phosphorus P)) with (percent percentage "%")) and (substrate dielectric interconnect interconnecting) | USPAT | 2006/03/23 13:08 |
| 9 | BRS | 266 | ((((cobalt Co) with (tungsten W) with (phosphorus P)) with (percent percentage "%")) and (substrate dielectric interconnect interconnecting) | US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/03/23 13:10 |